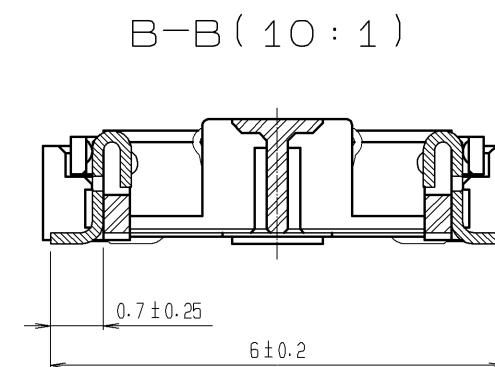
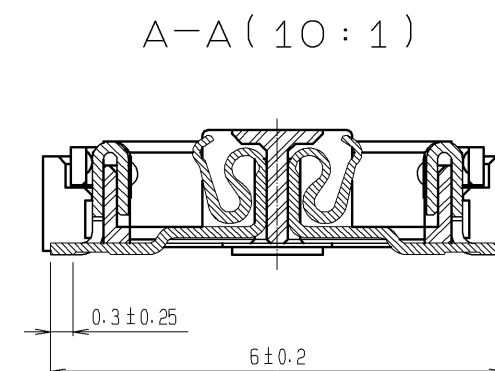
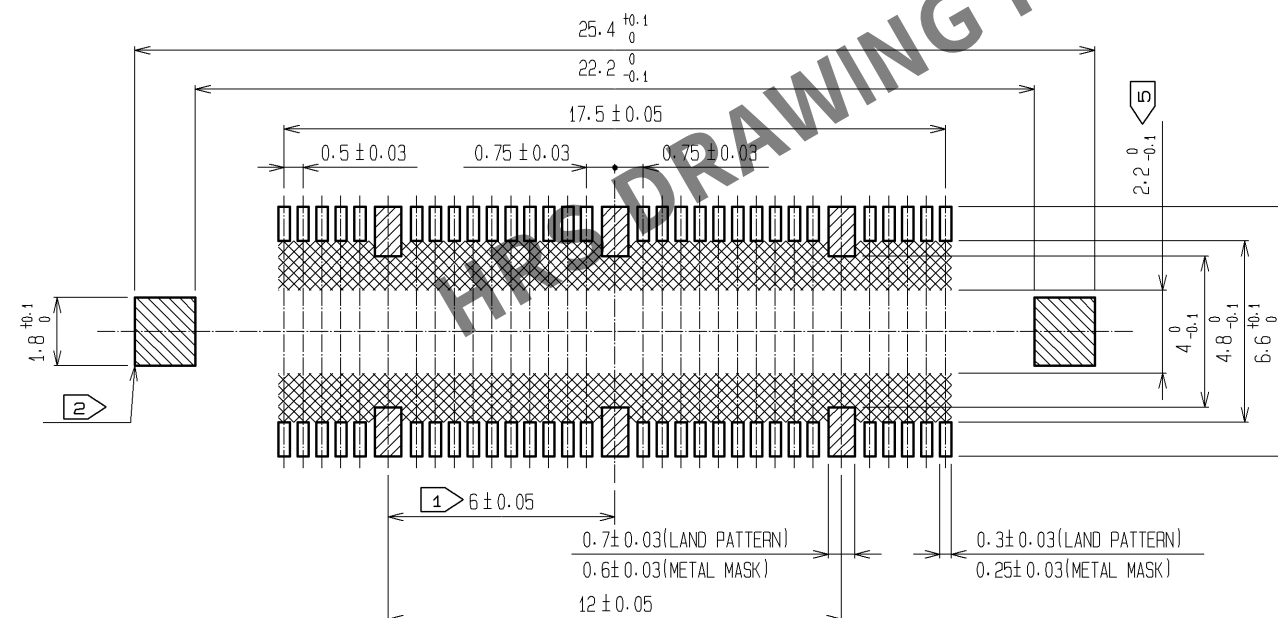
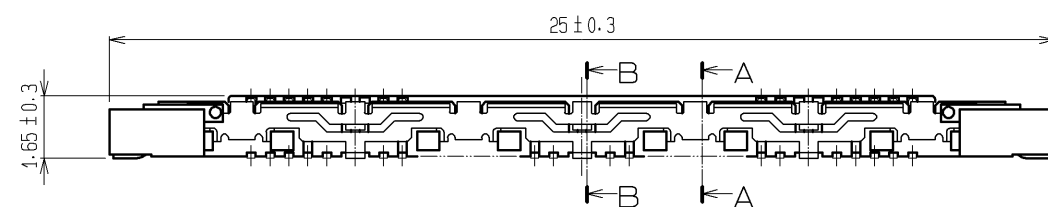
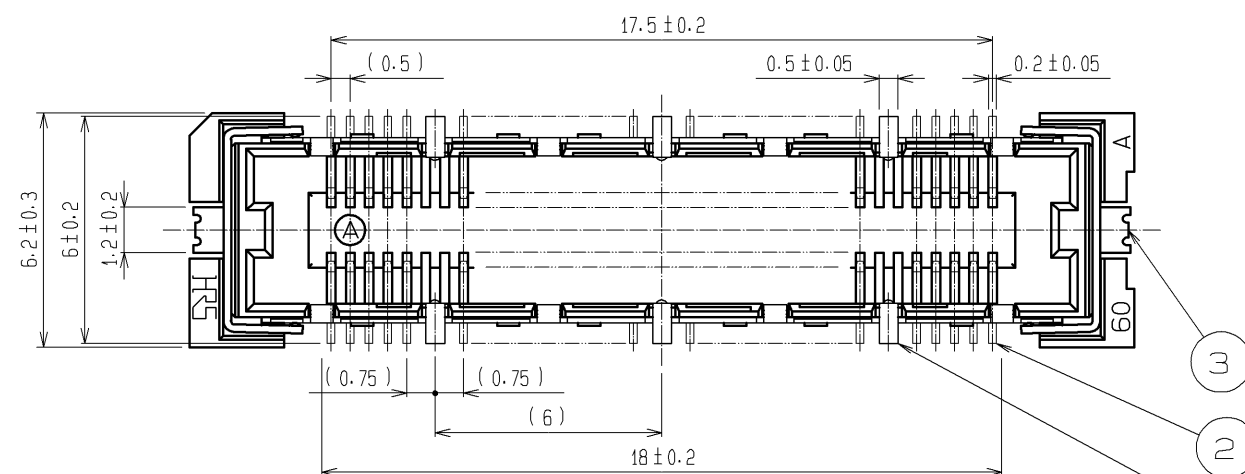




RECOMMENDED LAND PATTERN DIMENSION OF PCB

- NOTES
- 1 6 HATCHED  PARTS:GROUND CIRCUIT.
 - 2 2 HATCHED  PARTS:GROUND CIRCUIT.
 - 3 SMT LEAD-COPLANARITY:0.1 MAX.
 - 4 THIS PRODUCT HAS NO POLARITY TO PATTERN FOR MOUNTING.
 - 5 MAKE SURE WIDTH OF PATTERN IS WITHIN THAT OF LAND .OR LEAD MAY TOUCH PATTERN.(THIS APPLIES TO HATCHED  AREA.)
 - 6 THE DIMENSIONS IN PARENTHESES ARE FOR REFERENCE.

				4	PHOSPHOR BRONZE	TIN PLATING
				3	PHOSPHOR BRONZE	TIN PLATING
				2	PHOSPHOR BRONZE	CONTACT AREA : GOLD 0.1μm min.
						LEAD AREA : GOLD FLASH
						UNDER PLATING : NICKEL 1μm min.
1	LCP	BEIGE UL94V-0				
NO.	MATERIAL	FINISH , REMARKS		NO.	MATERIAL	FINISH , REMARKS

UNITS mm		SCALE 5 : 1		COUNT	DESCRIPTION OF REVISIONS	DESIGNED	CHECKED	DATE
HIROSE ELECTRIC CO., LTD.		APPROVED : HS. OKAWA	07.08.31	DRAWING NO.	EDC3-152112-25			
		CHECED : HS. OZAWA	07.08.31	PART NO.	FX11LB-60S/6-SV(71)			
		DESIGNED : TS. MIYAKI	07.08.30	CODE NO.	CL573-0112-5-71			
		DRAWN : TS. MIYAKI	07.08.30					